

TEXAS INSTRUMENTS

Product Content Sheet

Package family	QLPp	Picture of typical product, optional				
Date	28/Sep/2006					
Version	RoHS					
Composition part	Material group	Materials	CAS if applicable	Average mass [weight-%] *)	Sum [%]	Traces
Chip	Silicon and inorganic compounds	Si	7440-21-3	100	0.940999	-
Wires	Nobel Metal	Gold	7440-57-5	99.99	0.139895	-
Leadframe	Alloy	Copper	7440-50-8	96.6602	49.625027	-
		Iron	7439-89-6	2.1697	1.113917	-
		Phosphorus	7723-14-0	0.0724	0.037170	-
		Zinc	7440-66-6	0.1116	0.057295	-
		Lead	7439-92-1	0.0129	0.006623	
		Silver	7440-22-4	0.9732	0.499638	-
Mold compound	Silica and thermoset epoxy resin	Si fused	60676-86-0	86.91	37.506977	-
		Epoxy & Phenol resin	Confidential	12.78	5.515351	-
		Carbon Black	1333-86-4	0.31	0.133784	-
DA Epoxy	Ероху	Silver	7440-22-4	75	0.884539	-
		Epoxy Resin	Confidential	10	0.117939	
		Gamma Butyrolactone	96-48-0	5	0.058969	
		Amine	Confidential	5	0.058969	-
		Metal Oxide	Confidential	5	0.058969	-
Leadfinish	Metal Alloy	Sn	7440-31-5	100	3.243938	
Marking	Laser	Laser	-	-	-	
	1	L		Sum in total:	100	-

Weight range	0.159405g
Fluctuation margin	-

or:

Case sizes**) and weight range

*) related to package weight; weight in particular, see corresponding *package weight list* **) optional

Company	Texas Instruments Norway	Important remarks:		
Address	Gaustadalleen 21, 0349 Oslo, Norway	 Traces are product parts, substances etc. that are below a percentage of 0.1 % by weight. 		
Support	http://www-k.ext.ti.com/sc/technical- support/pic/euro.htm	Higher limits are accepted if the substance or material is legally regulated (see note no. 2).		
Internet	www.ti.com	 2) A list of the (legal) " restrictions on substances" or materials is available at internet address: http://www.eicta.org/Content/Default.asp?PageID=113 		



- 3) Substances, materials etc. with possible harmful effects on human beings and the environment are listed.
- There are no risks for human beings and to the environment if products are properly used as designated. This shall not apply to risks caused during procedures for disposal etc.
- All statements herein are based on our present knowledge. If our products are used properly, there are no risks to human beings and/or the environment.



Package Weight List

(Single weights of Products, materials data see **Product Content Sheet** on previous page)

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Package fa	amily	QLPp)				
Date		28/Sep/2006					
Version RoHS		S					
				Internal			
Uspec	Package	;		package	Pin	Weight	
short*)	family*)		Package	code	count	[grams]	Remark
			4x4x0.85 QLPp	QLPp 16	16	0.159405 g	Device: CC1150

*) USpec short name and Package family are optional, e.g. for summary of several package weight lists

Company	Texas Instruments Norway
Address	Gaustadalleen 21, 0349 Oslo, Norway
Support	http://www-k.ext.ti.com/sc/technical-support/pic/euro.htm
Internet	www.ti.com

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